

January 2012 UniFET™

Unit V

V

A

A

mJ

Α

mJ

V/ns

W

W/ºC °C

°C

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4.5

312

2.5

-55 to +150

300

Thermal Characteristics

Peak Diode Recovery dv/dt

1/8" from Case for 5 Seconds

Power Dissipation

 $(T_{C} = 25^{\circ}C)$

Operating and Storage Temperature Range

Maximum Lead Temperature for Soldering Purpose,

- Derate above 25°C

dv/dt

 P_D

T_{J,} T_{STG} T_{L}

Symbol	Parameter	Min.	Max.	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	-	0.4	°C/W
$R_{ hetaCS}$	Thermal Resistance, Case-to-Sink	0.24	-	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	-	40	°C/W

(Note 3)

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe,

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor

FDA38N30 N-Channel MOSFET

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDA38N30	FDA38N30	TO-3PN	-	-	30

Electrical Characteristics T_c = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
Off Charac	teristics	l			l	
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V, T_C = 25^{\circ}C$	300	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$	-	0.3	-	V/°C
I _{DSS} Zero		V _{DS} = 300V, V _{GS} = 0V	-	-	1	
	Zero Gate Voltage Drain Current	V _{DS} = 240V, T _C = 125 ^o C	-	-	10	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±30V, V _{DS} = 0V	-	-	±100	nA
On Charac	teristics	<u>_</u>				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 19A	-	0.07	0.085	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 20V, I_D = 19A$ (Note 4)	-	6.3	-	S
Dynamic C	Characteristics					
C _{iss}	Input Capacitance		-	2600	-	pF
C _{oss}	Output Capacitance	V _{DS} = 25V, V _{GS} = 0V f = 1MHz	-	500	-	pF
C _{rss}	Reverse Transfer Capacitance		-	60	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V = 240V L = 284	-	60	-	nC
Q _{gs}	Gate to Source Gate Charge	- V _{DS} = 240V, I _D = 38A V _{GS} = 10V	-	17	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(Note 4, 5)	-	28	-	nC
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	53	69	ns
t _r	Turn-On Rise Time	V _{DD} = 150V, I _D = 38A R _G = 25Ω, V _{GS} = 10V	-	110	143	ns
t _{d(off)}	Turn-Off Delay Time	$R_{\rm G} = 2502, V_{\rm GS} = 10V$	-	118	153	ns
t _f	Turn-Off Fall Time	(Note 4, 5)	-	54	70	ns
Drain-Sour	rce Diode Characteristics					
S Maximum Continuous Drain to Source Diode Forward Current				-	38	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current			-	150	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _{SD} = 38A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _{SD} = 38A	-	315	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_{\rm F}/dt = 100 {\rm A}/\mu {\rm s} $ (Note 4)	-	4.0	-	μC

NOTES:

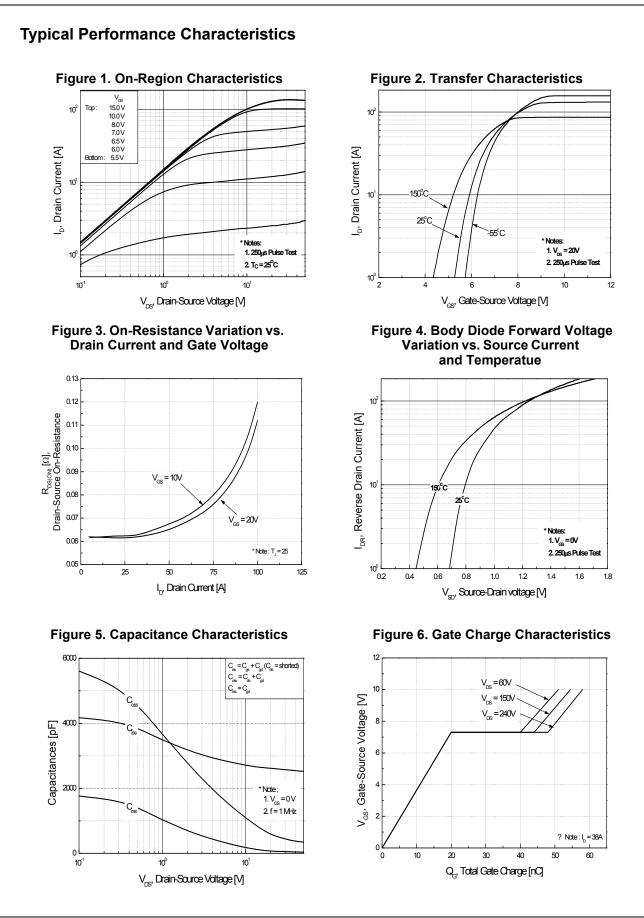
1. Repetitive Rating: Pulse width limited by maximum junction temperature

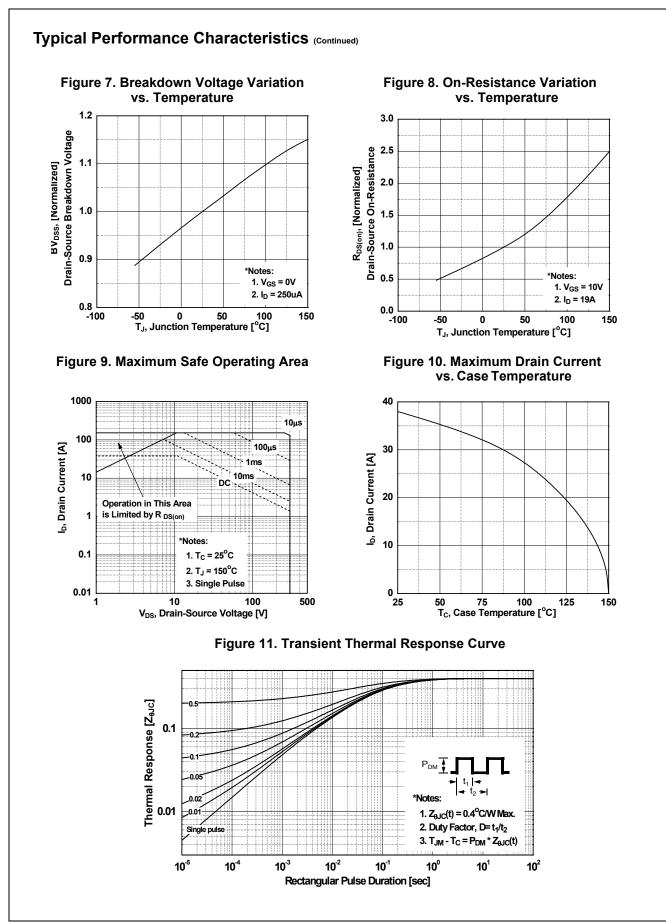
2. L = 1.7mH, I_{AS} = 38A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. I_{SD} \leq 38A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

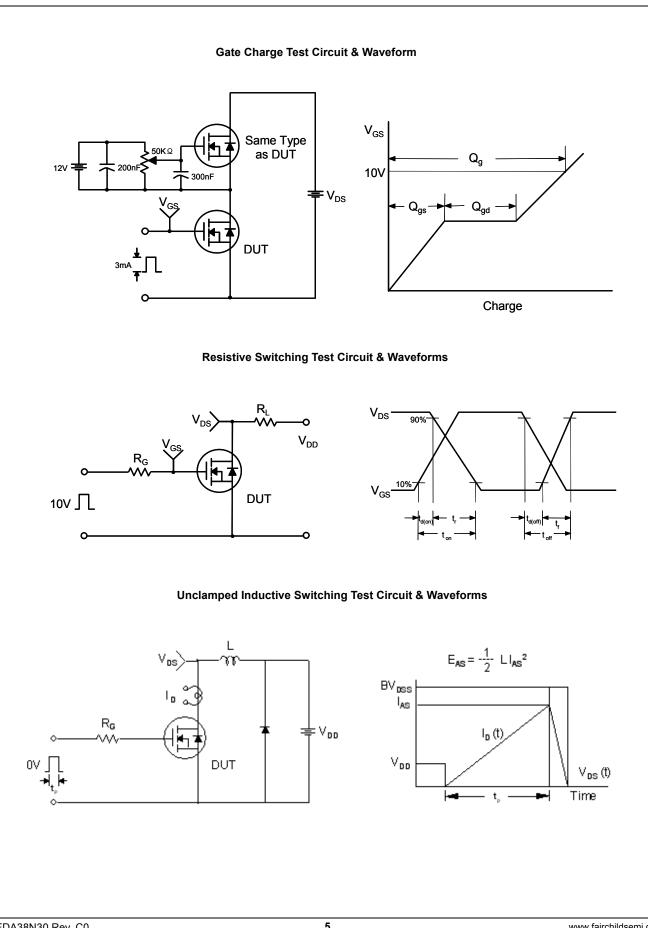
4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics



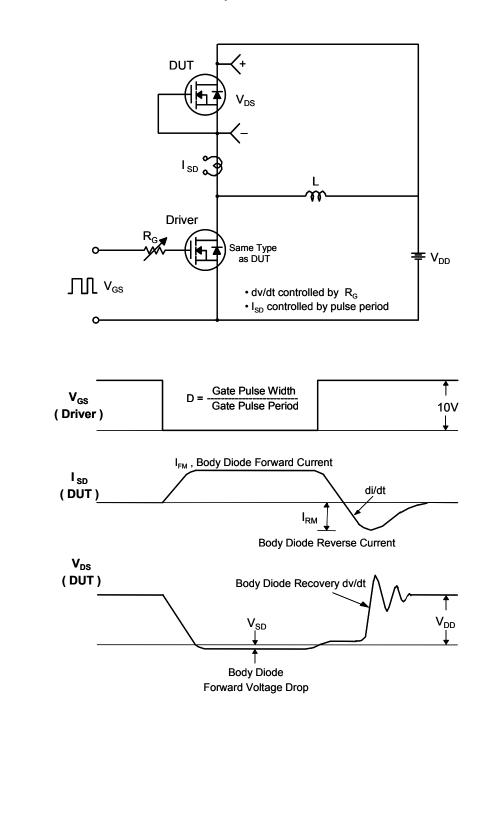


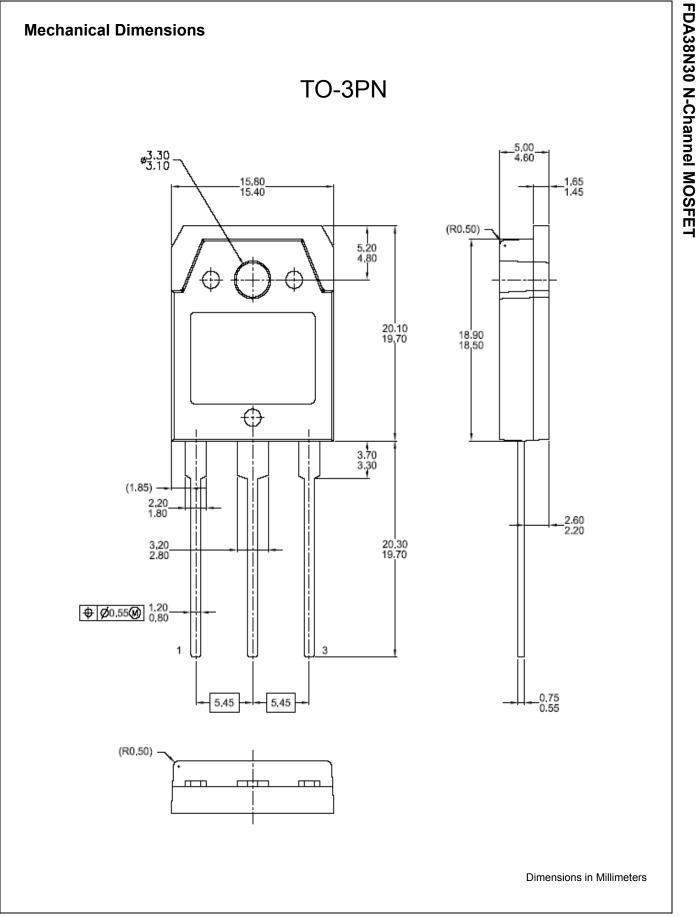
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Peak Diode Recovery dv/dt Test Circuit & Waveforms







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